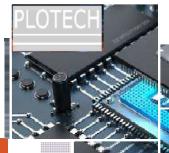


Statement of Comprehensive Income

Unit: NT\$ millions

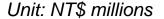
Item	1Q19	2Q19	3Q19	3Q18	QoQ	YoY
Net Revenue	691	839	765	1,069	-8.8%	-28.4%
Gross Margin	18.8%	18.0%	14.5%	15.9%	-4.5ppts	-1.4ppts
Operating Expenses	79	101	74	120	-27.7%	-38.3%
Operating Margin	7.4%	5.9%	4.8%	4.7%	-1.1ppts	-0.1ppts
Non-Operating Items	-2	-2	-8	-44	300.0%	-81.8%
Net Income After Tax	46	64	20	-6	-68.6%	433.3%
Net Profit Margin	6.7%	7.6%	2.7%	-0.5%	-4.9ppts	-3.2ppts
EPS (NT Dollar)	0.36	0.49	0.16	-0.04	-67.3%	500%

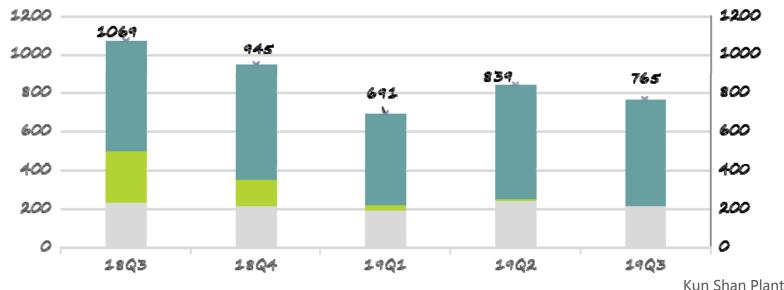




>>> Revenue Analysis







Stocktaking had taken place at Canton plant in the Q1 of 2019, no revenue showed in the Q2.

Major revenue in 2019 is from the Kun Shan plant and the Taiwan plant.

Kun Shan Plan Taiwan Plant



Kun Shan Plant:

Compared with the same period, revenue declined slightly.

(Sino-US trade affects the trade slightly and causes shipments delayed)

Product Niche of Kun Shan Plant

- HDI, Flex-Rigid and Rigid Boards, orders have started to increase every month in Q3.



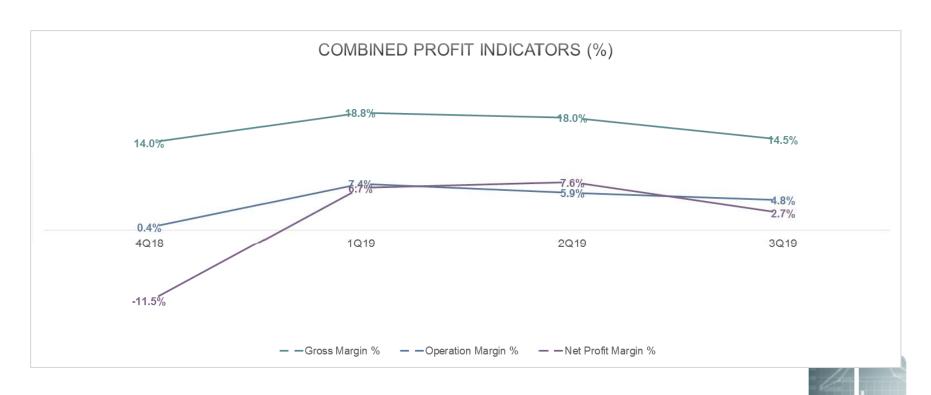
+

Compared with the same period of revenue, still kept the same.

Product Niche in Taiwan plant – IC test boards have increased significantly in the monthly revenue of 2019.

>> Combined Profit Indicators



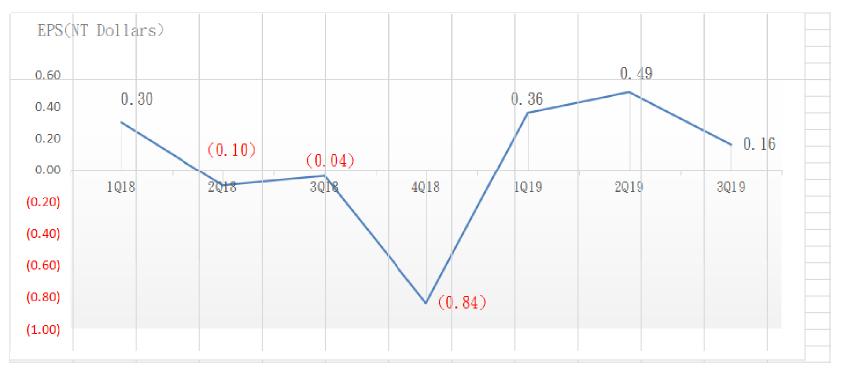






>> Consolidated Earnings per Share







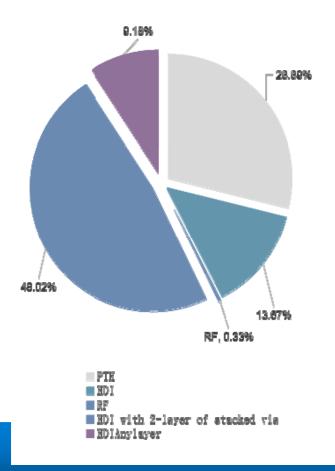


3Q19% of Revenue of Various

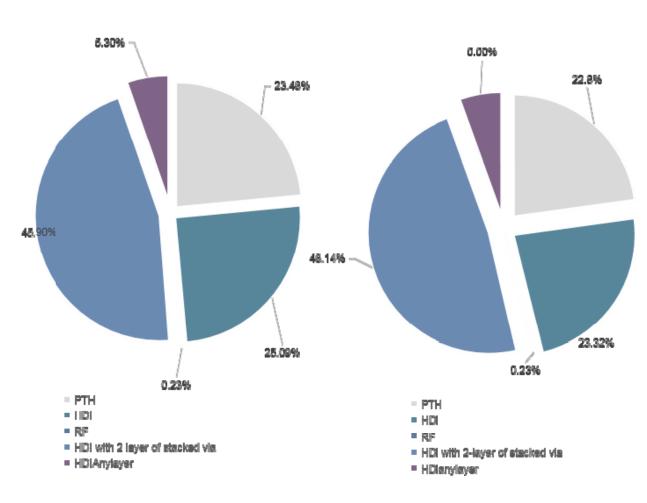
Production

>> Product Structure - Kun Shan Plant





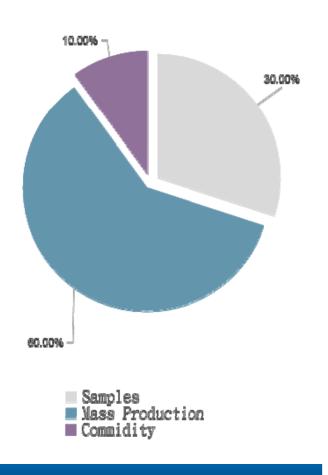




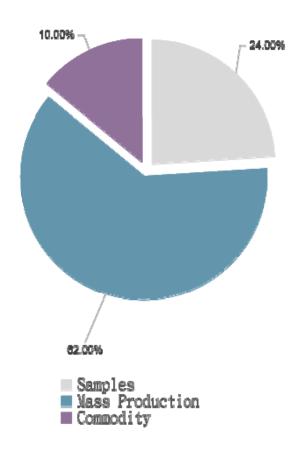




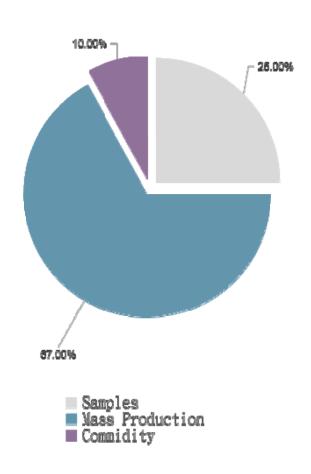
1Q19% of Revenue of Various Production



2Q19% of Revenue of Various Production

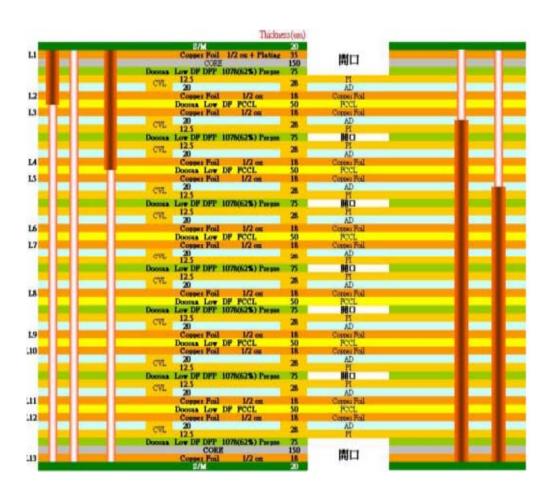


3Q19% of Revenue of Various Production





Capability of Process Design for Production





Thickness(um)

S/M		20		20	
	Copper Foil	1/3 oz + Plating	25		25
	oosan 1080MR(65%) Prepri		66		66
	Copper Foil(假層)	0.5 oz + Plating	25		25
CCL	PI	4.2mil	110		160
	Copper Foil	0.5oz	18		18
	san 1078(62%)non-flow Pre 2.90 mil		74		74
	CVL PI	1.45mil		12.5	
	CVL			25	
	Copper Foil	1/3 oz		12	
FCCL	PI	1.0 mil		25	
	Copper Foil	1/3 oz		12	
	CHT B	1.45mil		25	
	CVL PI			12.5	
	san 1078(62%)non-flow Pre 2.90 mil		74		74
	Copper Foil	0.5oz	18		18
CCL	PI	6.2mil	110		160
	Copper Foil(假層)	0.5 oz + Plating	25		25
	1000MR (65%) Prepri		66		66
		1/3 oz + Plating	25		25
S/M		20		20	

